

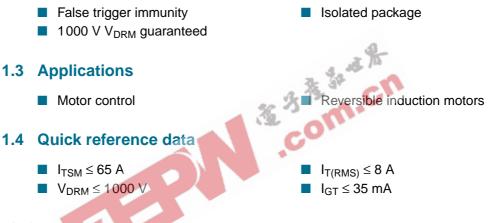
Product data sheet

1. Product profile

1.1 General description

Passivated high voltage, high commutation triac in a full pack, plastic package. This triac is intended for use in motor control circuits where high blocking voltage, high static and dynamic dV/dt as well as high dl/dt can occur. This device will commutate the full rated RMS current at the maximum rated junction temperature, without the aid of a snubber.

1.2 Features



2. Pinning information

Table 1:	Pinning		
Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)		
2	main terminal 2 (T2)	mb	T2-T1
3	gate (G)		`G sym051
mb	mounting base; isolated		

i 2 3 SOT186A (3-lead TO-220F)



Three quadrant triacs high commutation

3. Ordering information

Table 2: Ordering i	nformation		
Type number	Package		
	Name	Description	Version
BTA208X-1000C	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 'full pack'	SOT186A

4. Limiting values

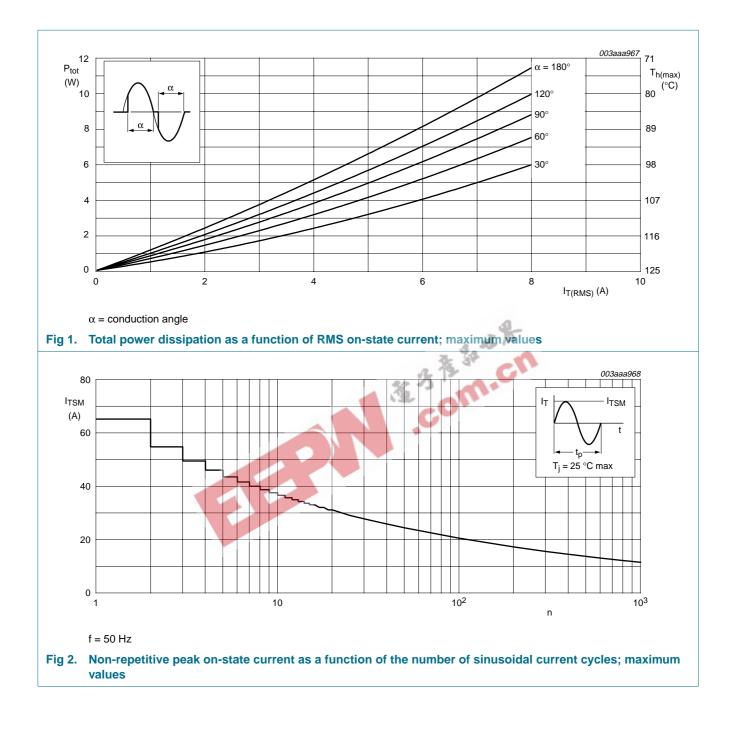
Table 3:Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	1000	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_h \le 73 \text{ °C}$; see Figure 4 and 5		8	А
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_i = 25 \text{ °C prior}$ to surge; see <u>Figure 2</u> and <u>3</u>	1 %		
		t = 20 ms	C	65	А
		t = 16.7 ms 🎇 🍊 👘	-	71	А
l ² t	I ² t for fusing	t = 10 ms	-	21	A ² s
dl _T /dt	rate of rise of on-state current	I _{TM} = 12 A; I _G = 0.2 A; dI _G /dt = 0.2 A/μs	-	100	A/μs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
T _i	junction temperature		-	125	°C

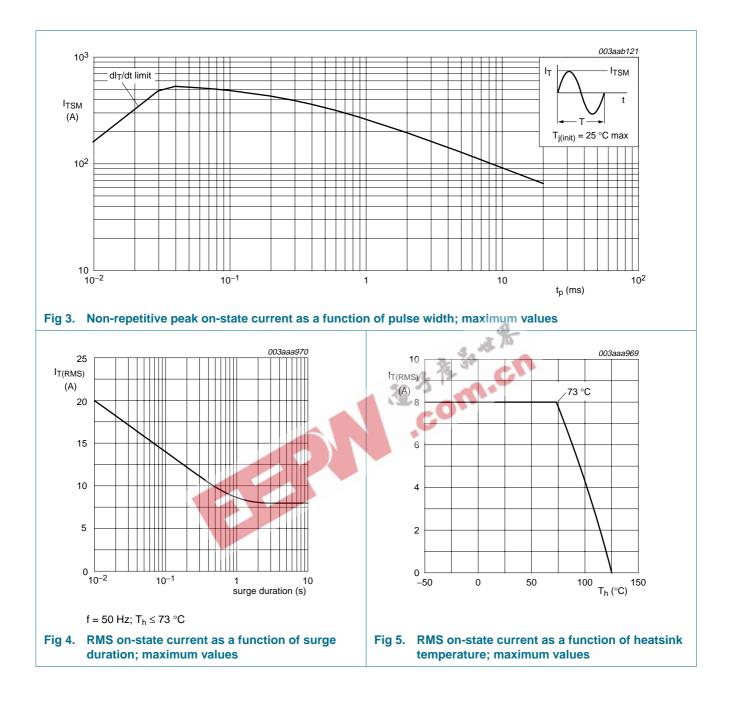
BTA208X-1000C

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BTA208X-1000C_1

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5. Thermal characteristics

Table 4:	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	see Figure 6	<u>[1]</u> _	-	4.5	K/W
		see Figure 6	[2] _	-	6.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	55	-	K/W

[1] Full or half cycle; with heatsink compound.

[2] Full or half cycle; without heatsink compound.

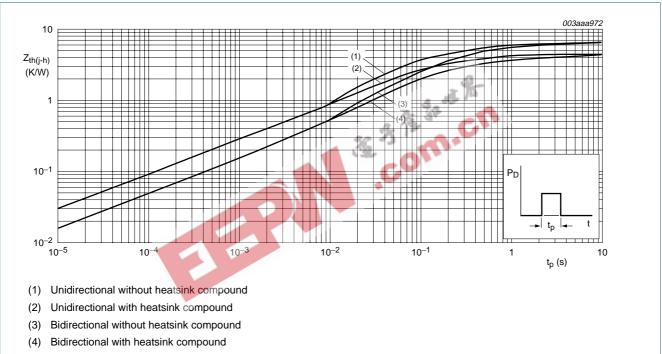


Fig 6. Transient thermal impedance from junction to heatsink as a function of pulse width

6. Isolation characteristics

Table 5: Isolation limiting values and characteristics

$T_h = 25 ^{\circ}C$ unless otherwise specified						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(rms)}	RMS isolation voltage	f = 50 Hz to 60 Hz; sinusoidal waveform; RH \leq 65 %; clean and dust free; from all three terminals to external heatsink	-	-	2500	V
C _{isol}	isolation capacitance	f = 1 MHz; from pin 2 to external heatsink	-	10	-	рF

BTA208X-1000C_1
Product data sheet

Three quadrant triacs high commutation

Characteristics 7.

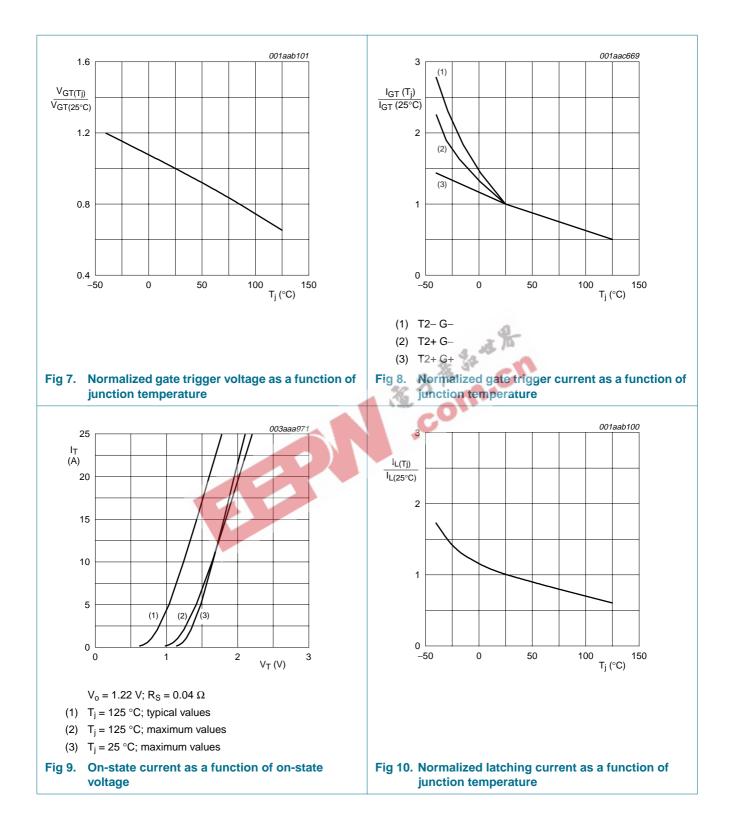
Table 0.	Unaracteristics
$T_j = 25 \circ C$	unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chai	acteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } Figure 8$	1]			
		T2+ G+	2	6	35	mA
		T2+ G-	2	13	35	mA
		T2– G–	2	23	35	mA
IL	latching current	V _D = 12 V; I _{GT} = 0.1 A; see Figure 10				
		T2+ G+	-	25	50	mA
		T2+ G-	-	48	75	mA
		T2– G–	-	30	50	mA
I _H	holding current	V _D = 12 V; I _{GT} = 0.1 A; see Figure 11	- 	20	50	mA
V _T	on-state voltage	I _T = 10 A; see <u>Figure 9</u>	2-34	1.3	1.65	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; see Figure 7	12	0.7	1.5	V
		$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 125 ^\circ\text{C}$	0.25	0.4	-	V
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \text{ °C}$	U.	0.1	0.5	mA
Dynamic c	haracteristics					
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 67 \% V_{DRM(max)};$ T _j = 125 °C; exponential waveform; gate open circuit	1000	4000	-	V/μs
dl _{com} /dt	rate of change of commutating current	$V_{DM} = 400 \text{ V}; T_j = 125 \text{ °C};$ $I_{T(RMS)} = 8 \text{ A};$ without snubber; gate open circuit; see Figure 12	12	32	-	A/ms
t _{gt}	gate-controlled turn-on time	$\begin{split} I_{TM} &= 12 \text{ A}; \text{V}_{\text{D}} = \text{V}_{\text{DRM}(\text{max})}; \\ I_{\text{G}} &= 0.1 \text{ A}; \text{d} \text{I}_{\text{G}}/\text{d} \text{t} = 5 \text{A}/\mu\text{s} \end{split}$	-	2	-	μs

[1] Device will not trigger in the T2– G+ quadrant.

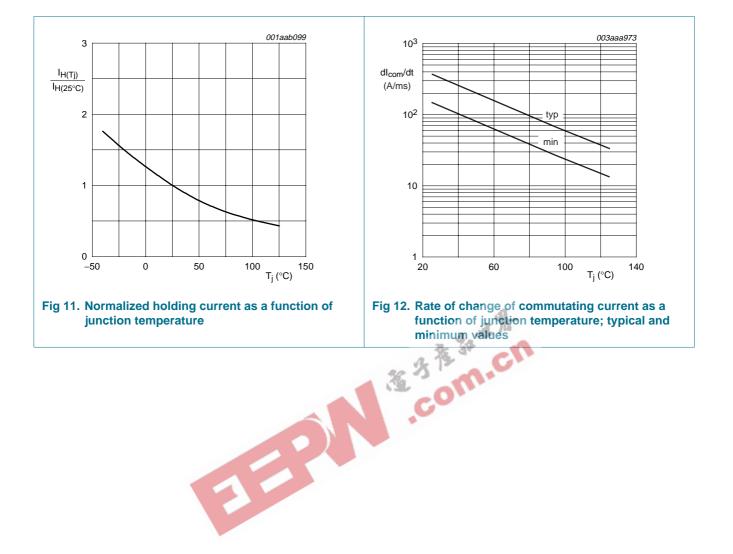
BTA208X-1000C

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BTA208X-1000C

Three quadrant triacs high commutation



BTA208X-1000C 1

BTA208X-1000C

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8. Package outline

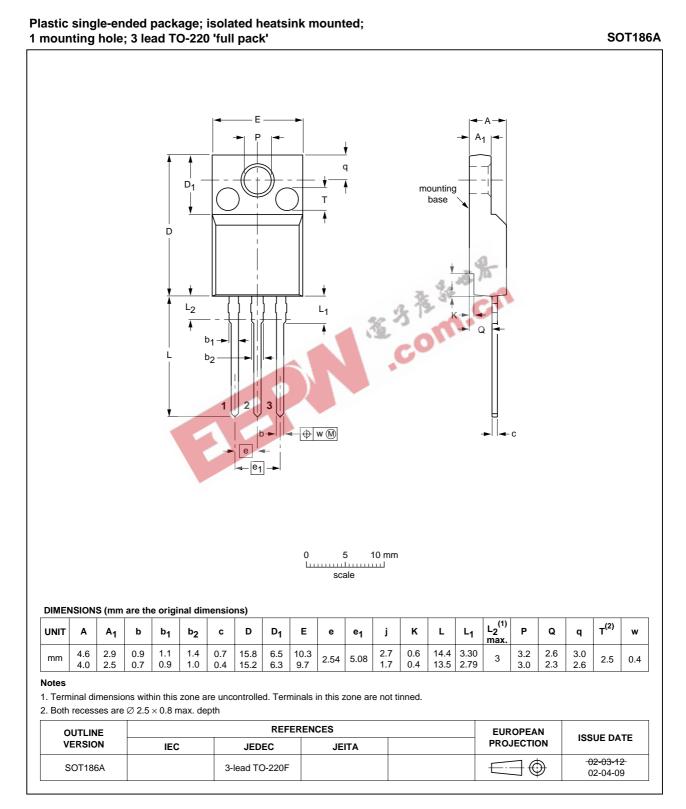


Fig 13. Package outline SOT186A (3-lead TO-220F)

Three quadrant triacs high commutation

9. Revision history

Table 7: Revision h					
Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
BTA208X-1000C_1	20051004	Product data sheet	-	-	-



Three quadrant triacs high commutation

10. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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BTA208X-1000C

Three quadrant triacs high commutation

15. Contents

1	Product profile 1
1.1	General description 1
1.2	Features
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 1
3	Ordering information 2
4	Limiting values 2
5	Thermal characteristics 5
6	Isolation characteristics 5
7	Characteristics 6
8	Package outline
9	Revision history 10
10	Data sheet status 11
11	Definitions 11
12	Disclaimers
13	Trademarks 11
14	Contact information
	a B C

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Date of release: 4 October 2005 Document number: BTA208X-1000C_1



